

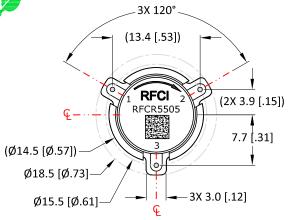


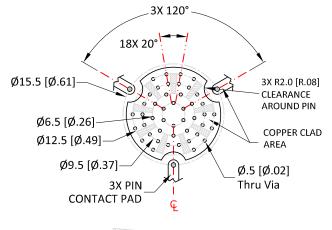
	REVISIONS						
REV	DESCRIPTION	ECO	DATE	APPROVED			
Α	RELEASE		06/24/15	P.T			

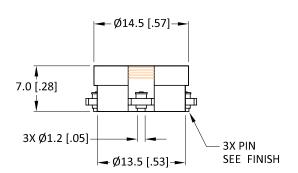
DWG. NO.

REV









### SolderMask Pattern

# Recommended Footprint Copper-Solder Mask Pattern

The Land Pattern should be with good thermal conductivity

#### Finish:

- 1. Housing: Silver plated
- 2. Pin: Gold plated
- 3. Coplanarity specification: 0.10 [.004] MAX.

# **Specifications**

Parameter	Minimum	Typical	Maximum
Frequency Range (MHz)	1805		1880
Insertion Loss (dB)		< .22	.30
Isolation (dB)	20	> 23	
Return Loss (dB)	20	> 23	
FWD IMD: 2T at 37W per T		70	
5MHz Spacing (dBc)		70	

# Power & Temperature Ratings

Parameter	Maximum	
Forward PWR Peak/AVG	500/100 Watts	
Reverse Power CW	80 Watts	
Operating Temperature	-40 to +85° C	
Storage Temperature	-50 to +125° C	

#### NOTES:

- 1. Typical Values Represent Performance @ +23 °C.
- 2. S-Parameters to be measured by connecting Port 1 and 2 to VNA, and Port 3 to Load with return loss 30dB or higher

## CW SMD CIRCULATOR MODEL: RFCR5505

